AMENDMENT UNDER 37 C.F.R. § 1.111 Attorney Docket No.: Q94136

Application No.: 10/580,342

AMENDMENTS TO THE CLAIMS

This listing of claims will replace all prior versions and listings of claims in the application:

LISTING OF CLAIMS:

1. (currently amended): A holding structure for an electronic part, comprising:

including a first resin mold which has a positioning shape portion for the electronic part;

and

a second resin mold which is insert-molded so as to cover the first resin mold and the

electronic part positioned with the first resin mold, characterized in that

the second resin being provided with a connector joined to the electronic part,

said-the positioning shape portion of said-the first resin mold is provided with a through

hole for allowing an insert resin material to pass therein to form the second resin mold.

2. (original): A holding structure for an electronic part, as claimed in claim 1, wherein

said positioning shape portion has a cup-shaped configuration in which the electronic part is

adapted to be inserted.

3. (original): A holding structure for an electronic part, as claimed in claim 2, wherein

said through hole is provided in a bottom wall of said positioning shape portion.

4. (original): A holding structure for an electronic part, as claimed in claim 3, wherein

said through hole provided in said bottom wall of said positioning shape portion includes two

through holes.

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5. (original): A holding structure for an electronic part, as claimed in claim 2, wherein

said through hole is provided in a side wall of said positioning shape portion.

6. (original): A holding structure for an electronic part, as claimed in claim 3, wherein

said through hole provided in said side wall of said positioning shape portion includes two

through holes.

7. (original): A holding structure for an electronic part, as claimed in claim 1, wherein a

gap is provided between an inner wall surface of said positioning shape portion with a cup-

shaped configuration, in which the electronic part is adapted to be inserted, and the electronic

part.

8. (original): A holding structure for an electronic part, as claimed in claim 1, wherein

said through hole guides said insert resin material to form said second resin mold into said

positioning shape portion.

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